

REV.	ECN NO.	DESCRIPTION	DRAW	CHECK	APPD.	DATE
A0	—	NEW	Elaine	—	—	2016.11.11
B0	ECN171031001	修改图面与实物相符	Michael	JOHNNY	JOHNNY	2017.10.30

NOTES:

1. MATERIAL:

- 1.1 HOUSING: HIGH TEMPERATURE THERAL PLASTIC.
- 1.2 SPRING CONTACT: COPPER ALLOY.
- 1.3 FLAT CONTACT: COPPER ALLOY
- 1.4 SHELL : COPPER ALLOY.
- 1.5 COVER: HIGH TEMPERATURE THERAL PLASTIC.

2. FINISH:

- 2.1 CONTACT: (SEE P/N.), [50m"] MIN. NICKEL UNDERPLATING OVER ALL.
- 2.2 SHELL: [50m"] MIN. SOLDERABLITY NICKEL UNDERPLATING OVER ALL.

料号备注

T10-3 F 236 D ×× T ×× ××

12=半金雾锡10"
13=半金雾锡30"
14=半金雾锡50"
15=半金雾锡150"
16=半金雾锡300"

R=ROHS2.0标准
W=无卤+ROHS2.0
H=REACH标准
B=盐雾24H
C=盐雾48H

00=LCP蓝 铜壳镀镍

PIN NO.	PIN 1	PIN 2	PIN 3	PIN 4
SLGNL NAME	V BUS	D-	D+	GND
REMARK	USB 2.0 CONTACT PINS			

PIN NO.	PIN 5	PIN 6	PIN 7	PIN 8	PIN 9
SLGNL NAME	STDA_SSRX-	STDA_SSRX+	GND_DRAIN	STDA_SSTX-	STDA_SSTX+
REMARK	USB 3.0 CONTACT PINS				

东莞市田都电子有限公司

DongGuan TianDu Electronics Co.,Ltd

ITEM	PART NAME	Material	Q'TY	REMARK
1	Shell	C2680	1	T=0.3
2	4Pin Contact	C5191	4	T=0.20
3	5Pin Contact	C2680	5	T=0.20
4	Housing	LCP+30%GF	1	Blue UL94V-0
5	COVER	LCP+30%GF	1	Blue UL94V-0

UNLESS OTHERWISE SPECIFIED
TOLERANCES

METRIC
X. +/- 0.30
.X +/- 0.20
.XX +/- 0.15
FRACTIONS +/-
ANGLES +/- 2.00°

DIMENSIONS
(METRIC) (MM)

APPROVAL

制图 Michael

审核

核准

文件位置

ANGLE OF PROJECTION



日期

2017.10.30

品名
规格

USB 3.0 AF 180度DIP铜壳
直脚无边H=11.5

料号

SEE TABLE

字张

A4

比例

工程图号:

TDU-USBAF-2196

版本

B0

1 : 1

状态码 W

页数 1

OF 1

